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U.S. UTILITY Patent Application

PATENT NUMBER and  
ISSUE DATE

APPL. NO.	FILED DATE	CLASS	SUBCLASS	GAU	EXAMINER
10022260	12/30/01	207	65	2014	W. H. A.
APPLICANTS: Oki Makoto; Oki Takahiro;					
COMPLETION DATE VERIFIED:					
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ATTORNEY DOCKET NO. OKI 200					
TITLE: Semiconductor package and method of fabricating same					

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
ISSUE FEE			Total Claims	Print Claim for O.G.
Amount Due	Date Paid	Primary Examiner	DRAWING	
DISCLAIMER			Sheets Drwg.	Figs. Drwg.
		PREPARED FOR ISSUE	Application Examiner	
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